imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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GaAlAs High Power IR LED Emitters **PDI-E809**



PACKAGE DIMENSIONS INCH [mm] 0.984 [25.00] -0.059 [1.50] 0.342 [8.70] ANODE CLEAR BLUE CATHODE PLASTIC 2° æ Ø0.197 [5.00] G 0.100 [2.54] 0.020 [0.50] SQ 0.039 [1.00] 2 PLACES 0.059 [1.50] MAX Ø0.220 [5.60]

BLUE TINT T 1¾ PACKAGE

FEATURES High output power

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High reliability

Narrow emission angle

DESCRIPTION

The PDI-E809 is a high power 880 nm GaAlAs emitter, packaged in a low cost T 1¾ plastic package.

APPLICATIONS

- · Photoelectric switches
- · Infrared sources

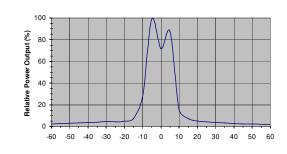
· Optical readers



ABSOLUTE MAXIMUM RATING (TA)= 23°C UNLESS OTHERWISE NOTED

SYMBOL	PARAMETER	MIN	MAX	UNITS	
P _d	Power Dissipation		200	mW	
I _f	Continuous Forward Current		100	mA	
Ι _ρ	Peak Forward Current		1	А	
Vr	Reverse Voltage		5	V	
T _{STG}	Storage Temperature	-25	+100	°C	
Τo	Operating Temperature	-25	+100	°C	
Ts	Soldering Temperature*		+240	°C	

RADIATION PATTERN



* 1/16 inch from case for 3 seconds max.

ELECTRO-OPTICAL CHARACTERISTICS RATING (TA)= 23°C UNLESS OTHERWISE NOTED

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
Po	Radiant Intensity	$I_f = 50 \text{ mA}$	50	90		mW/Sr
V _f	Forward Voltage	l _f = 100 mA		1.6	2.0	V
Vr	Reverse Breakdown Voltage	I _f = 100 μA	5	30		V
λ_{p}	Peak Wavelength	I _f = 50 mA		880		nm
$\Delta\lambda$	Spectral Bandwidth @ 50% (FWHM)	$I_f = 50 \text{ mA}$		70		nm
Ct	Terminal Capacitance	$V_r = 0V$, f = 1MHz		20		pF
t _r	Rise Time	$I_f = 20 \text{ mA}$		1.5		uS
t _f	Fall Time	I _f = 20 mA		0.8		uS

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